



920476-904743

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE THE APPLICATION OF

Philip Andrew Anslow et al.

SERIAL NO.: 0/451,127

FILED: November 30, 1999

FOR: High Density Printed Wiring Board Having
In-Via Surface Mounting Pads

) Examiner: Jeremy C. Norris

)

) Group Art Unit: 2827

)

) Confirmation Number: 8621

)

) Date Allowed: December 24, 2003

)

) Customer Number: 23644

)

I hereby certify that this correspondence is being deposited
with the United States Postal Service as first class mail in an
envelope addressed to "Commissioner for Patents, P.O. Box
1450, Alexandria, VA 22313-1450," on March 9, 2004

Name of person signing Jennifer J. Ramirez

Signature _____

SUBMISSION OF FORMAL DRAWINGS

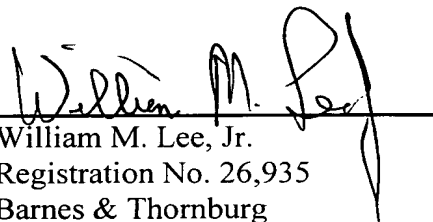
Honorable Director of Patents and Trademarks
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Submitted herewith are 6 sheets of formal drawings for the above-identified application.

March 8, 2004

Respectfully submitted,



William M. Lee, Jr.

Registration No. 26,935

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